

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3736960

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TOMOHIRO NAKAYA	02/08/2016
KAZUYOSHI NISHINO	02/08/2016
RECEIVING PARTY DATA	
Name:	SHIMADZU CORPORATION
Street Address:	1, NISHINOKYO-KUWABARACHO
Internal Address:	NAKAGYO-KU, KYOTO-SHI
City:	KYOTO 604-8511
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14911483
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	ANDREW F. YOUNG, ESQ.
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ATTORNEY DOCKET NUMBER:	SUGTA.P005
NAME OF SUBMITTER:	ANDREW F. YOUNG
SIGNATURE:	/AFY/
DATE SIGNED:	02/12/2016
Total Attachments: 3	
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source=doc06882120160212124617#page3.tif	

**RECORDATION FORM COVER SHEET
PATENTS ONLY**

To: Commissioner of Patents and Trademarks: Please record the attached original document or copy:

1. Name of conveying party(ies):

TOMOHIRO NAKAYA

KAZUYOSHI NISHINO

Additional names? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name:

SHIMADZU CORPORATION

1, NISHINOKYO-KUWABARACHO

NAKAGYO-KU, KYOTO-SHI

KYOTO 604-8511, JAPAN

Additional names & addresses attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date.

2/8/2016

4. Application number(s) or patent number(s): **14/911,483** DOCKET NO.: **SUGTA.P005**

If this document is being filed together with a new application, execution date of application is: NA

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence should be mailed: Address associated with **Customer**
No.: 28752

Name: _____

Internal Address: _____

Street Address: _____

City: _____ State: _____ ZIP: _____

6. Total number of applications and patents involved: 1

7. ☒ Charge any additional fees in connection with this submission to our Deposit Account No. **10-0100**

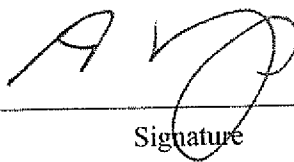
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Andrew F. Young, Reg. No. 44,001

Name of Person Signing



Signature

FEBRUARY 12, 2016

Date

Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned inventors:

Name	Address
Inventor (1): TOMOHIRO NAKAYA	residing at: 1, NISHINOKYO-KUWABARACHO, NAKAGYO-KU, KYOTO-SHI KYOTO 604-8511, JAPAN Citizenship: JAPAN
Inventor (2): KAZUYOSHI NISHINO	residing at: 1, NISHINOKYO-KUWABARACHO, NAKAGYO-KU, KYOTO-SHI KYOTO 604-8511, JAPAN Citizenship: JAPAN

declare that they are citizens of the country indicated above and with residences as listed above,

Hereby sell, assign and transfer to **SHIMADZU CORPORATION**, a corporation of the Nation of Japan hereafter called the "Assignee," having a place of business at:

1, Nishinokyo-Kuwabaracho, Nakagyo-ku, Kyoto-shi, Kyoto 604-8511, JAPAN,

To its successors, assigns and legal representatives, the entire right, title and interest for the United States and worldwide, in and to any and all improvements which are described and claimed in the

_____ attached specification executed on _____,
X specification Serial No. **14/911,483** filed **FEBRUARY 11, 2016**
 _____ U.S. Letters Patent No. _____; issued _____,

entitled: IMAGE PROCESSING DEVICE

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States or worldwide on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States or worldwide on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said

improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

The undersigned further declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

DATE 8 / February, 2016

TOMOHIRO NAKAYA (L.S.)
By: TOMOHIRO NAKAYA

DATE 8 / February, 2016

Kazuyoshi Nishino (L.S.)
By: KAZUYOSHI NISHINO